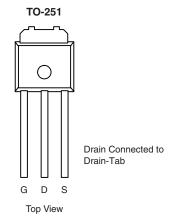


N-Channel 200-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{(BR)DSS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
200	0.038 at V _{GS} = 15 V	40	57		
200	0.043 at V _{GS} = 10 V	35	37		



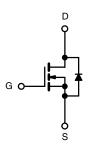
FEATURES

- Trench Power MOSFETS
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested



APPLICATIONS

- Power Supply
- Lighting Systems



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	200	V		
Gate-Source Voltage		V _{GS}	V _{GS} ± 25		
Continuous Drain Current (T,I = 175 °C)	T _C = 25 °C	1-	40	Α	
Continuous Diain Current (1) = 175 C)	T _C = 100 °C	I _D	26		
Pulsed Drain Current	I _{DM}	150	A		
Single Pulse Avalanche Current	ngle Pulse Avalanche Current L = 0.1 mH		20		
Single Pulse Avalanche Energy ^a	L = 0.1 IIII1	E _{AS}	20	mJ	
	T _C = 25 °C	D	146 ^b	W	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	$ P_{D}$	3.12		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W
Junction-to-Case (Drain)	R _{thJC}	0.75	

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.5	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Cata Dadu Laglaria	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Gate-Body Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			± 300		
		V _{DS} = 200 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 200 V, V _{GS} = 0 V, T _J = 100 °C			25		
		V _{DS} = 200 V, V _{GS} = 0 V, T _J = 150 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
		V _{GS} = 10 V, I _D = 20 A		0.038		Ω	
Durin Course Co Chala Durintana	_B	$V_{GS} = 15 \text{ V}, I_D = 20 \text{ A}$		0.043			
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 100 ^{\circ}\text{C}$		0.088			
		V _{GS} = 10 V, I _D = 20 A, T _J = 150 °C		0.120			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	25			S	
Dynamic ^b	-			•			
Input Capacitance	C _{iss}			3100		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		300			
Reverse Transfer Capacitance	C _{rss}			135			
Tatal Cata Charma ^C	0	$V_{DS} = 100 \text{ V}, V_{GS} = 15 \text{ V}, I_D = 50 \text{ A}$		85	127	nC	
Total Gate Charge ^c	Q _g			57	85		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$		14			
Gate-Drain Charge ^c	Q_{gd}			20			
Gate Resistance	R _g	f = 1 MHz		1.2	1.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}			16	25		
Rise Time ^c	t _r	V_{DD} = 100 V, R_L = 2 Ω		170	260		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		27	42	ns -	
Fall Time ^c	t _f			9	18		
Source-Drain Diode Ratings and Cha	aracteristics 7	C = 25 °C					
Continuous Current	I _S			I	36		
Pulsed Current	I _{SM}				80	A	
Forward Voltage ^a	V _{SD}	I _F = 20 A, V _{GS} = 0 V		0.86	1.5	V	
Reverse Recovery Time	t _{rr}			116	175	ns	
Peak Reverse Recovery Current	I _{RM(REC)}			9	14	Α	
Reverse Recovery Charge	Q _{rr}	I _F = 40 A, di/dt = 100 A/μs		0.53	0.8	μC	
Reverse Recovery Fall Time	t _a			84			
Reverse Recovery Rise Time	t _b			32		nS	

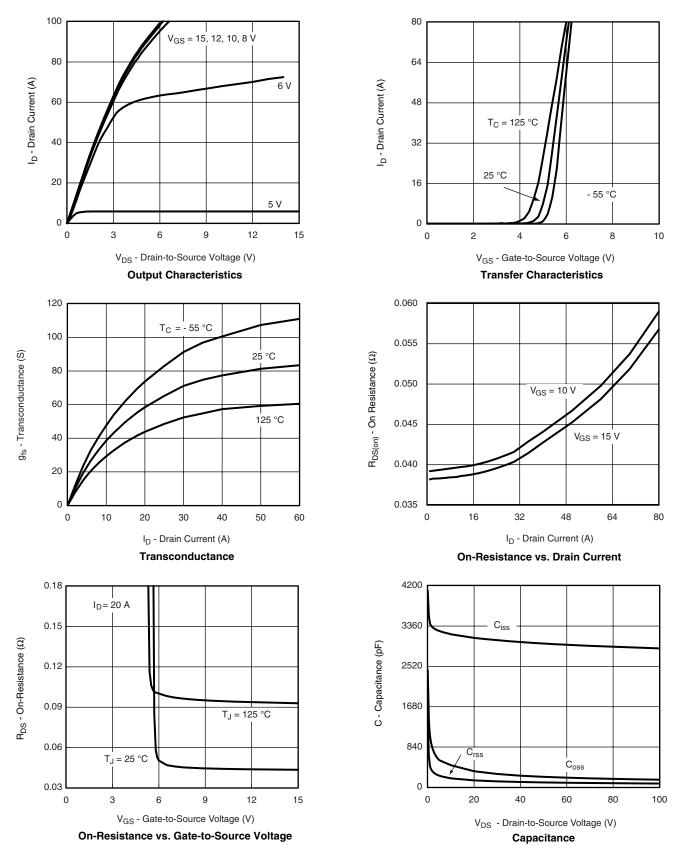
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

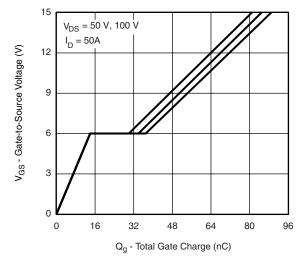


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

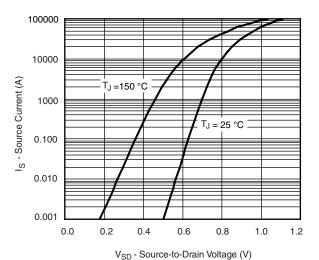




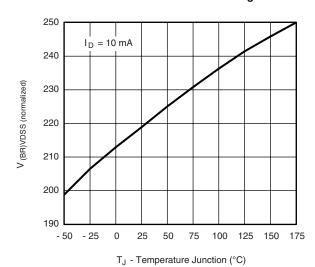
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





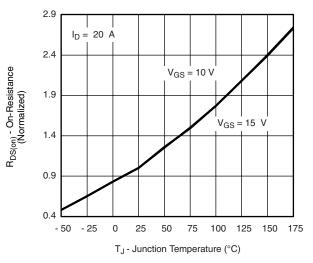


Source-Drain Diode Forward Voltage

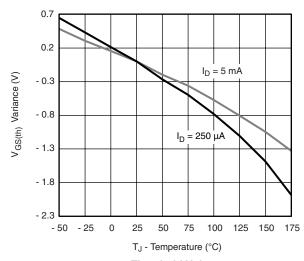


Drain Source Breakdown vs. Junction Temperature

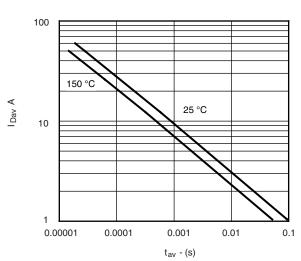
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On-Resistance vs. Junction Temperature



Threshold Voltage

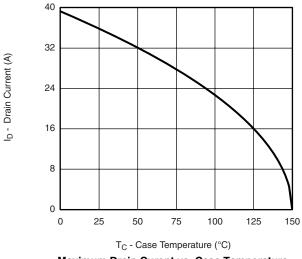


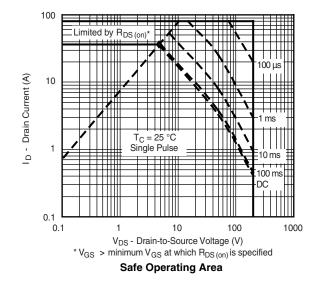
Single Pulse Avalanche Current Capability vs. Time

Normalized Effective Transient Thermal Impedance

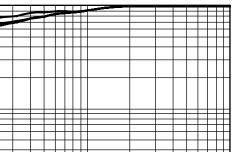


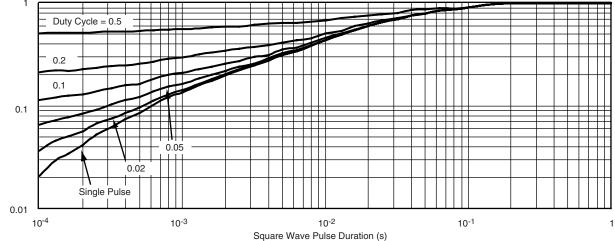
THERMAL RATINGS





Maximum Drain Curent vs. Case Temperature





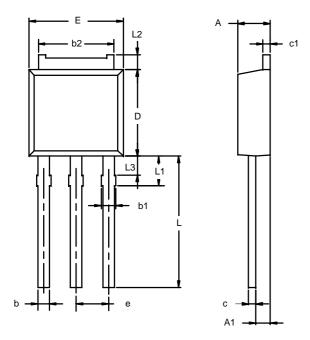
Normalized Thermal Transient Impedance, Junction-to-Case

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TO-251AA



Note:	Dimension	I 3 is for	reference	only
MOLE.	DITTIETISION	L3 15 101	reference	OHILY.

	MILLIM	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
с1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090	BSC	
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-03946—Rev. E. 09-Jul-01					

ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346



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